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Vishay General Semiconductor

AUTOMOTIVE

ROHS

HALOGEN FREE

High Current Density Surface Mount Ultrafast Rectifiers





PRIMARY CHARACTERISTICS					
I _{F(AV)}	2 x 2.0 A				
V_{RRM}	100 V, 150 V, 200 V				
I _{FSM}	40 A				
t _{rr}	25 ns				
V _F at I _F = 2.0 A	0.77 V				
T _J max.	175 °C				
Package	TO-277A (SMPC)				
Diode variations	Common cathode				

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer computer, automotive, and telecommunication applications.

FEATURES

- Very low profile typical height of 1.1 mm
- · Ideal for automated placement
- · Oxide planar chip junction
- · Ultrafast recovery times for high frequency
- Low forward voltage drop, low power loss
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

MECHANICAL DATA

Case: TO-277A (SMPC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and

commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and

automotive grade

Terminals: Matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER		SYMBOL	UH4PBC	UH4PCC	UH4PDC	UNIT
Device marking code			H4BC	H4CC	H4DC	
Maximum repetitive peak reverse voltage		V_{RRM}	100	150	200	V
Maximum average forward rectified current (fig. 1)	total devive		4.0		А	
	per diode	I _{F(AV)}	2.0			
Peak forward surge current 10 ms single half sine-wave superimposed on rated load per diode		I _{FSM}	40			А
Operating junction and storage temperature range		T _J , T _{STG}	-55 to +175			°C



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Instantaneous forward voltage per diode	I _F = 1.0 A	T _A = 25 °C	V _F ⁽¹⁾	0.84	-	V	
	I _F = 2.0 A			0.93	1.05		
	I _F = 1.0 A	T _A = 125 °C		0.68	-		
	I _F = 2.0 A			0.77	0.85		
Reverse current per diode	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	5	μА	
	Rated V _R	T _A = 125 °C		6.4	25		
Maximum reverse recovery time per diode	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		- t _{rr}	20	25	ns	
Typical reverse recovery time per diode	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, \\ V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$			24	-		
Typical softness factor (t _b /t _a)per diode	$ \begin{array}{l} I_F = 2 \text{ A, dI/dt} = 200 \text{ A/µs,} \\ V_R = 200 \text{ V, } I_{rr} = 0.1 I_{RM} \\ T_A = 125 ^{\circ}\text{C} \end{array} $		S	0.3	-	-	
Typical reverse recovery current per diode			I _{RM}	5.4	-	Α	
Typical stored charge per diode			Q _{rr}	88	-	nC	
Typical junction capacitance per diode	4.0 V, 1 MHz		CJ	21	-	pF	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

 $^{(2)}$ Pulse test: Pulse width $\leq 40 \text{ ms}$

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	UH4PBC	UH4PCC	UH4PDC	UNIT	
Typical thermal resistance per diode	R ₀ JA (1)	60			°C/W	
Typical trieffial resistance per diode	$R_{ heta JL}$	4				

Note

(1) Units mounted on recommended PCB 1 oz. pad layout

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
UH4PDC-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel			
UH4PDC-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel			
UH4PDCHM3/86A (1)	0.10	86A	1500	7" diameter plastic tape and reel			
UH4PDCHM3/87A (1)	0.10	87A	6500	13" diameter plastic tape and reel			

Note

(1) Automotive grade



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

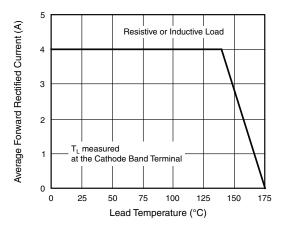


Fig. 1 - Maximum Forward Current Derating Curve

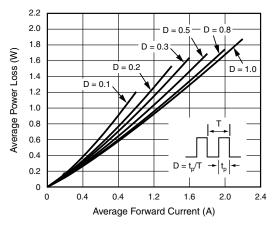


Fig. 2 - Forward Power Loss Characteristics Per Diode

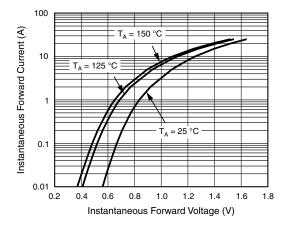


Fig. 3 - Typical Instantaneous Forward Characteristics Per Diode

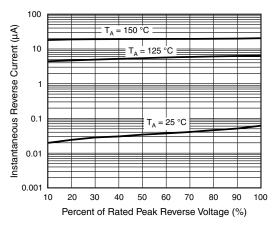


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

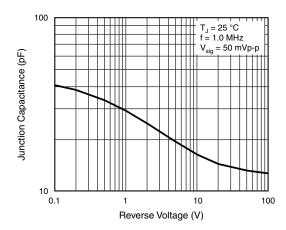


Fig. 5 - Typical Junction Capacitance Per Diode

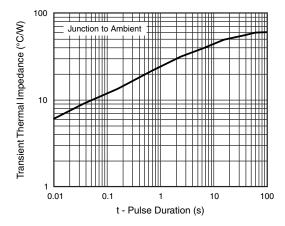
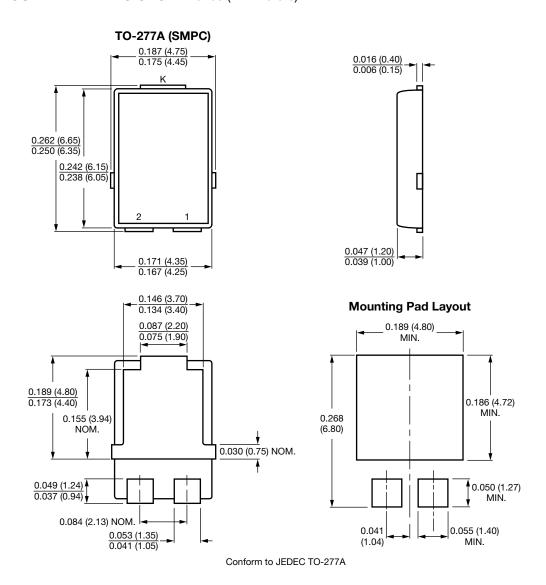


Fig. 6 - Typical Transient Thermal Impedance Per Diode



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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